

☐ Classification of Defects in Solids: **Planar defects:**

☐ Planar defects:

- ✓ Stacking faults
 - {311} defects in Si
 - Inversion domain boundaries
 - Antiphase boundaries (e.g., super dislocations): analogous to partials but in an ordered material (GaN)

- ✓ Interfaces

- ✓ Grain boundaries
 - Phase boundaries
 - Tilt boundaries
 - Twist boundaries
 - Twin boundaries

☐ Comparison of Packing of Atoms in the FCC & HCP Structures:

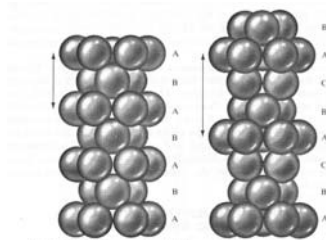
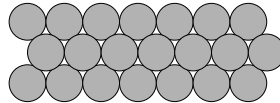


Figure 1-20 The manner in which close-packed layers of spheres can be stacked in sequence to produce (left) the hexagonal-close-packed (H.C.P.) structure and (right) the cubic-close-packed (F.C.C.) structure. After L. Pauling, *The Nature of the Chemical Bond* (Cornell, 1960).

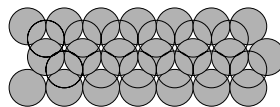
Planar Defects in Materials

- Comparison of Packing of Atoms in the FCC Structures:

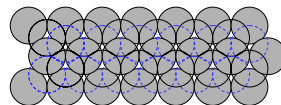
Stacking sequence in FCC
Crystals for (111) planes:
ABCABC



Plane A
Or
A sites



Plane B
Or
B sites



Plane C
Or
C sites

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Dislocations in Materials

- Mentioned earlier:** Propagation of a dislocation that leaves the crystal unchanged in its atomic arrangement is referred to as a "perfect" dislocation.
- Example: b for "perfect" dislocation in FCC lattice:
✓ $b = a_0/2 [110]$
- If the Elastic Strain Energy around a dislocation is large enough, the dislocation may dissociate into two dislocations whose b 's are smaller.
- Driving Force:** Reducing strain energy
- This will occur if:

$$b_1^2 > b_2^2 + b_3^2$$

Franks rule:

- The "smaller" dislocations are called **Partial Dislocations**.
- The dissociation of a perfect dislocation into partial dislocations will create a planar defect between the two partial dislocations referred to as a **Stacking Fault (SF)**.
- Stacking Fault:** discontinuity in the stacking sequence.
- The distance between two partial dislocation represents a balance between the action of two forces:
 - ✓ The stress fields of the partials cause mutual repulsion.
 - ✓ The energy of the SF that stretches between them causes attraction.

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Dislocations in Materials

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Partial Dislocations:

- ✓ Dissociation of a *perfect dislocation* into *Partial Dislocations* and the creation of a *Stacking Fault* (SF) is shown below:

(a)

(b)

Stacking sequence in FCC Crystals for {111} planes:
Unfaulted: ABCABC
Faulted: ABCA/CABC
 Or
Faulted: ABCAB/ABC

(c)

FIGURE 2.17 (a) Path of whole and partial (Shockley) dislocations; (b) Shockley b_1 and b_2 surrounding stacking fault region A; (c) Long stacking fault ribbons (bands of closely spaced lines) in low SFE 18Cr-8Ni stainless steel. Faults are bounded at ends by partial dislocations. This black bands are mechanical twins. (After Michalak;¹⁶ reprinted with permission from *Metals Handbook*, Vol. 8, American Society for Metals, Metals Park, OH, © 1973.)

I think Hull & Bacon?

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Partial Dislocations:

- ✓ Stacking Sites in {111} planes of a FCC crystal:

Stacking sequence in FCC Crystals for {111} planes:
Unfaulted: ABCABC
Intrinsic Stacking Fault: ABCA/CABC
Extrinsic Stacking Faulted: ABCAB/ABC

Plane B Or B sites Plane C Or C sites Plane B Or B sites

Partial dislocation Faulted Section Partial dislocation $\perp = b$

Plane C Or C sites

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□ Planar defects:

✓ Stacking faults

o {311} defects in Si

- Rod-like defect along $\langle 110 \rangle$ direction
- Consists of interstitials precipitating on {311} planes
- Deposits as a single monolayer of 5-7 member hexagonal rings of Si.
- This atomic arrangement provides a way to insert planes of I w/o dangling bonds giving rise to a very stable defect.

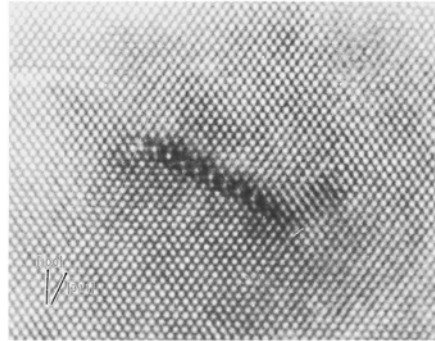


FIG. 2. Cross-section HREM showing {311} defect habit plane, and typical image contrast of {311} defects.

Eaglesham, Stolk, Gossman & Poate, *APL*, **65**, (1994) 2305

2306 *Appl. Phys. Lett.*, Vol. 65, No. 18, 31 October 1994

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□ Planar defects:

✓ Grain boundaries:

o High angle

o Low angle

o Phase boundary:

- two phases rather than one in a polycrystalline material.

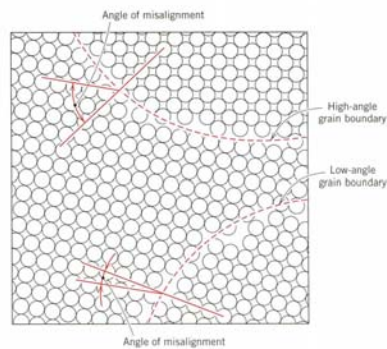


FIGURE 4.7 Schematic diagram showing low- and high-angle grain boundaries and the adjacent atom positions.

W. McCallister, 5th Ed

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☐ Planar defects:

✓ **Tilt boundary** is a special type of small angle grain boundary:

- o Boundary is defined by an array of *edge dislocations* that are perpendicular to the *angle of misorientation, θ* .

✓ **Twist boundary** is another special type of small angle grain boundary

- o Boundary is defined by an array of *screw dislocations* that are parallel to the *angle of misorientation, θ* .

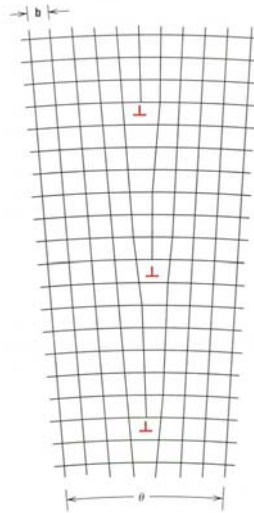


FIGURE 4.8 Demonstration of how a tilt boundary having an angle of misorientation θ results from an alignment of edge dislocations.

☐ Planar defects:

✓ Twin boundary:

- o Special type of grain boundary
- o It is defined by symmetry across the boundary
 - *Mirror plane*
- o Region between boundary is call a *twin*.
- o They are created by:
 - Applied mechanical shear forces
 - Thermal annealing following plastic deformation

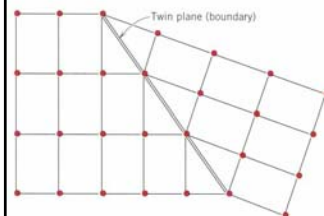
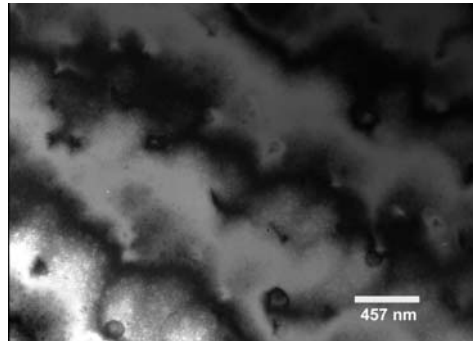


FIGURE 4.9 Schematic diagram showing a twin plane or boundary and the adjacent atom positions (dark circles).

Bulk Defects in Materials

Bulk/Volume defects:

- ✓ Precipitates
- ✓ Vacancy agglomeration ([see Shimura, S/C Silicon Crystal Technology, p.57, fig. 3.29b](#))
 - o D-defects in Si
- ✓ Cracks, grooves, pits

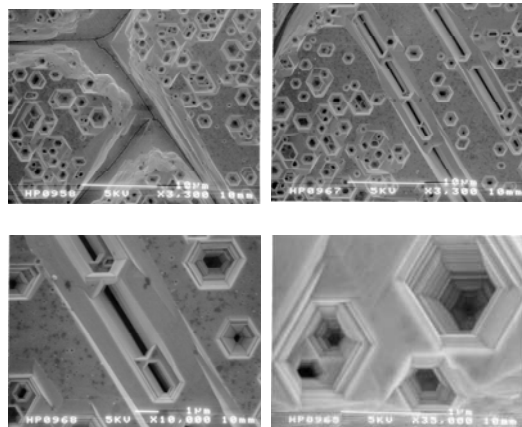


- D-defects known to cause gate oxide degradation
- D-defects created during crystal growth

Bulk Defects in Materials

Bulk/Volume defects:

- ✓ Cracks
- ✓ Pits
- ✓ Grooves



- SEM of MOCVD GaN